

## LM4030 SOT-23 Ultra-High Precision Shunt Voltage Reference

Check for Samples: [LM4030](#)

### FEATURES

- High Output Voltage Accuracy 0.05%
- Low Temperature Coefficient 10 ppm/°C
- Extended Temperature Operation -40-125°C
- Excellent Thermal Hysteresis, 75ppm
- Excellent Long-Term Stability, 40ppm
- High Immunity to Board Stress Effects
- Capable of Handling 50 mA Transients
- Voltage Options 2.5V, 4.096V
- SOT-23 Package

### APPLICATIONS

- Data Acquisition/Signal path
- Test and Measurement
- Automotive & Industrial
- Communications
- Instrumentation
- Power Management

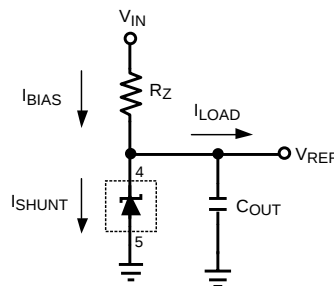
### DESCRIPTION

The LM4030 is an ultra-high precision shunt voltage reference, having exceptionally high initial accuracy (0.05%) and temperature stability (10ppm/°C). The LM4030 is available with fixed voltage options of 2.5V and 4.096V. Despite the tiny SOT-23 package, the LM4030 exhibits excellent thermal hysteresis (75ppm) and long-term stability (40ppm) as well as immunity to board stress effects.

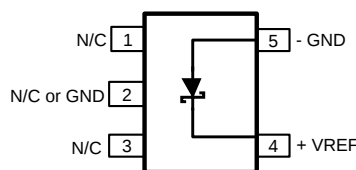
The LM4030 is designed to operate without an external capacitor, but any capacitor up to 10μF may be used. The LM4030 can be powered off as little as 120μA (max) but is capable of shunting up to 30mA continuously. As with any shunt reference, the LM4030 can be powered off of virtually any supply and is a simple way to generate a highly accurate system reference.

The LM4030 is available in three grades (A, B, and C). The best grade devices (A) have an initial accuracy of 0.05% with ensured temperature coefficient of 10 ppm/°C or less, while the lowest grade parts (C) have an initial accuracy of 0.15% and a temperature coefficient of 30 ppm/°C.

### Typical Application Circuit



### Connection Diagram



**SOT-23 Package  
(Top View)**



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**PIN DESCRIPTIONS**

| Pin # | Name     | Function                       |
|-------|----------|--------------------------------|
| 1     | N/C      | No connect pin, leave floating |
| 2     | GND, N/C | Ground or no connect           |
| 3     | N/C      | No connect pin, leave floating |
| 4     | VREF     | Reference voltsge              |
| 5     | GND      | Ground                         |



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

**Absolute Maximum Ratings** <sup>(1)(2)</sup>

|                                                               |                |
|---------------------------------------------------------------|----------------|
| Maximum Voltage on any input                                  | -0.3 to 6V     |
| Power Dissipation ( $T_A = 25^\circ\text{C}$ ) <sup>(3)</sup> | 350mW          |
| Storage Temperature Range                                     | -65°C to 150°C |
| Lead Temperature (soldering, 10sec)                           | 260°C          |
| Vapor Phase (60 sec)                                          | 215°C          |
| Infrared (15sec)                                              | 220°C          |
| ESD Susceptibility <sup>(4)</sup><br>Human Body Model         | 2kV            |

- (1) Absolute Maximum Ratings indicate limits beyond which damage may occur to the device. Operating Ratings indicate conditions for which the device is intended to be functional, but do not ensure specific performance limits. For ensured specifications, see Electrical Characteristics.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.
- (3) Without PCB copper enhancements. The maximum power dissipation must be de-rated at elevated temperatures and is limited by  $T_{JMAX}$  (maximum junction temperature),  $\theta_{J-A}$  (junction to ambient thermal resistance) and  $T_A$  (ambient temperature). The maximum power dissipation at any temperature is:  $P_{DISSMAX} = (T_{JMAX} - T_A) / \theta_{J-A}$  up to the value listed in the Absolute Maximum Ratings.  $\theta_{J-A}$  for SOT-23 package is 220°C/W,  $T_{JMAX} = 125^\circ\text{C}$ .
- (4) The human body model is a 100 pF capacitor discharged through a 1.5 kΩ resistor into each pin.

**Operating Ratings**

|                                      |                 |
|--------------------------------------|-----------------|
| Maximum Continuous Shunt Current     | 30mA            |
| Maximum Shunt Current (<1s)          | 50mA            |
| Junction Temperature Range ( $T_J$ ) | -40°C to +125°C |

## Electrical Characteristics

### LM4030-2.5 ( $V_{OUT} = 2.5V$ )

Limits in standard type are for  $T_J = 25^\circ C$  only, and limits in boldface type apply over the junction temperature ( $T_J$ ) range of  $-40^\circ C$  to  $+125^\circ C$ . Minimum and Maximum limits are ensured through test, design, or statistical correlation. Typical values represent the most likely parametric norm at  $T_J = 25^\circ C$ , and are provided for reference purposes only.

| Symbol                            | Parameter                                                      | Conditions                               | Min <sup>(1)</sup> | Typ <sup>(2)</sup> | Max <sup>(1)</sup> | Unit             |
|-----------------------------------|----------------------------------------------------------------|------------------------------------------|--------------------|--------------------|--------------------|------------------|
| $V_{REF}$                         | Reverse Breakdown Voltage                                      | $I_{SHUNT} = 120\mu A$                   |                    | 2.5                |                    | V                |
|                                   | Reverse Breakdown Voltage Tolerance ( $I_{SHUNT} = 120\mu A$ ) |                                          |                    |                    |                    |                  |
|                                   | LM4030A-2.5                                                    | (A Grade - 0.05%)                        | -0.05              |                    | 0.05               | %                |
|                                   | LM4030B-2.5                                                    | (B Grade - 0.10%)                        | -0.10              |                    | 0.10               | %                |
|                                   | LM4030C-2.5                                                    | (C Grade - 0.15%)                        | -0.15              |                    | 0.15               | %                |
| $I_{RMIN}$                        | Minimum Operating Current                                      |                                          |                    |                    | <b>120</b>         | $\mu A$          |
| TC                                | Temperature Coefficient <sup>(3)</sup>                         |                                          |                    |                    |                    |                  |
|                                   | LM4030A-2.5                                                    | $0^\circ C \leq T_J \leq +85^\circ C$    |                    |                    | <b>10</b>          | ppm / $^\circ C$ |
|                                   |                                                                | $-40^\circ C \leq T_J \leq +125^\circ C$ |                    |                    | <b>20</b>          | ppm / $^\circ C$ |
|                                   | LM4030B-2.5                                                    | $-40^\circ C \leq T_J \leq +125^\circ C$ |                    |                    | <b>20</b>          | ppm / $^\circ C$ |
|                                   | LM4030C-2.5                                                    | $-40^\circ C \leq T_J \leq +125^\circ C$ |                    |                    | <b>30</b>          | ppm / $^\circ C$ |
| $\Delta V_{REF}/\Delta I_{SHUNT}$ | Reverse Breakdown Voltage Change with Current                  | $160\mu A \leq I_{SHUNT} \leq 30mA$      |                    | 25                 | <b>110</b>         | ppm / mA         |
| $\Delta V_{REF}$                  | Long Term Stability <sup>(4)</sup>                             | 1000 Hrs, $T_A = 30^\circ C$             |                    | 40                 |                    | ppm              |
| $V_{HYST}$                        | Thermal Hysteresis <sup>(5)</sup>                              | $-40^\circ C \leq T_J \leq +125^\circ C$ |                    | 75                 |                    | ppm              |
| $V_N$                             | Output Noise Voltage <sup>(6)</sup>                            | 0.1 Hz to 10 Hz                          |                    | 105                |                    | $\mu V_{PP}$     |

- (1) Limits are 100% production tested at  $25^\circ C$ . Limits over the operating temperature range are ensured through correlation using Statistical Quality Control.
- (2) Typical numbers are at  $25^\circ C$  and represent the most likely parametric norm.
- (3) Temperature coefficient is measured by the "Box" method; i.e., the maximum  $\Delta V_{REF}$  is divided by the maximum  $\Delta T$ .
- (4) Long term stability is  $V_{REF}$  @  $25^\circ C$  measured during 1000 hrs. This measurement is taken for  $I_R = 500\mu A$ .
- (5) Thermal hysteresis is defined as the change in  $+25^\circ C$  output voltage before and after cycling the device from  $(-40^\circ C$  to  $125^\circ C)$  eight times.
- (6) Low frequency peak-to-peak noise measured using first-order 0.1 Hz HPF and second-order 10 Hz LPF.

## Electrical Characteristics

### LM4030-4.096 ( $V_{OUT} = 4.096V$ )

Limits in standard type are for  $T_J = 25^\circ C$  only, and limits in boldface type apply over the junction temperature ( $T_J$ ) range of  $-40^\circ C$  to  $+125^\circ C$ . Minimum and Maximum limits are ensured through test, design, or statistical correlation. Typical values represent the most likely parametric norm at  $T_J = 25^\circ C$ , and are provided for reference purposes only.

| Symbol                           | Parameter                                                      | Conditions                               | Min <sup>(1)</sup> | Typ <sup>(2)</sup> | Max <sup>(1)</sup> | Unit             |
|----------------------------------|----------------------------------------------------------------|------------------------------------------|--------------------|--------------------|--------------------|------------------|
| $V_{REF}$                        | Reverse Breakdown Voltage                                      | $I_{SHUNT} = 130\mu A$                   |                    | 4.096              |                    | V                |
|                                  | Reverse Breakdown Voltage Tolerance ( $I_{SHUNT} = 130\mu A$ ) |                                          |                    |                    |                    |                  |
|                                  | LM4030A-4.096                                                  | (A Grade - 0.05%)                        | -0.05              |                    | 0.05               | %                |
|                                  | LM4030B-4.096                                                  | (B Grade - 0.10%)                        | -0.10              |                    | 0.10               | %                |
|                                  | LM4030C-4.096                                                  | (C Grade - 0.15%)                        | -0.15              |                    | 0.15               | %                |
| $I_{RMIN}$                       | Minimum Operating Current                                      |                                          |                    |                    | <b>130</b>         | $\mu A$          |
| TC                               | Temperature Coefficient <sup>(3)</sup>                         |                                          |                    |                    |                    |                  |
|                                  | LM4030A-4.096                                                  | $0^\circ C \leq T_J \leq +85^\circ C$    |                    |                    | <b>10</b>          | ppm / $^\circ C$ |
|                                  |                                                                | $-40^\circ C \leq T_J \leq +125^\circ C$ |                    |                    | <b>20</b>          | ppm / $^\circ C$ |
|                                  | LM4030B-4.096                                                  | $-40^\circ C \leq T_J \leq +125^\circ C$ |                    |                    | <b>20</b>          | ppm / $^\circ C$ |
|                                  | LM4030C-4.096                                                  | $-40^\circ C \leq T_J \leq +125^\circ C$ |                    |                    | <b>30</b>          | ppm / $^\circ C$ |
| $\Delta V_{REF}/\Delta I_{LOAD}$ | Reverse Breakdown Voltage Change with Current                  | $160\mu A \leq I_{SHUNT} \leq 30mA$      |                    | 15                 | <b>95</b>          | ppm / mA         |

- (1) Limits are 100% production tested at  $25^\circ C$ . Limits over the operating temperature range are ensured through correlation using Statistical Quality Control.
- (2) Typical numbers are at  $25^\circ C$  and represent the most likely parametric norm.
- (3) Temperature coefficient is measured by the "Box" method; i.e., the maximum  $\Delta V_{REF}$  is divided by the maximum  $\Delta T$ .

**Electrical Characteristics****LM4030-4.096 ( $V_{OUT} = 4.096V$ ) (continued)**

Limits in standard type are for  $T_J = 25^\circ C$  only, and limits in boldface type apply over the junction temperature ( $T_J$ ) range of  $-40^\circ C$  to  $+125^\circ C$ . Minimum and Maximum limits are ensured through test, design, or statistical correlation. Typical values represent the most likely parametric norm at  $T_J = 25^\circ C$ , and are provided for reference purposes only.

| Symbol           | Parameter                           | Conditions                               | Min <sup>(1)</sup> | Typ <sup>(2)</sup> | Max <sup>(1)</sup> | Unit         |
|------------------|-------------------------------------|------------------------------------------|--------------------|--------------------|--------------------|--------------|
| $\Delta V_{REF}$ | Long Term Stability <sup>(4)</sup>  | 1000 Hrs, $T_A = 30^\circ C$             |                    | 40                 |                    | ppm          |
| $V_{HYST}$       | Thermal Hysteresis <sup>(5)</sup>   | $-40^\circ C \leq T_J \leq +125^\circ C$ |                    | 75                 |                    | ppm          |
| $V_N$            | Output Noise Voltage <sup>(6)</sup> | 0.1 Hz to 10 Hz                          |                    | 165                |                    | $\mu V_{PP}$ |

(4) Long term stability is  $V_{REF}$  @  $25^\circ C$  measured during 1000 hrs. This measurement is taken for  $I_R = 500 \mu A$ .

(5) Thermal hysteresis is defined as the change in  $+25^\circ C$  output voltage before and after cycling the device from  $(-40^\circ C$  to  $125^\circ C)$  eight times.

(6) Low frequency peak-to-peak noise measured using first-order 0.1 Hz HPF and second-order 10 Hz LPF.

## Typical Performance Characteristics for 2.5V

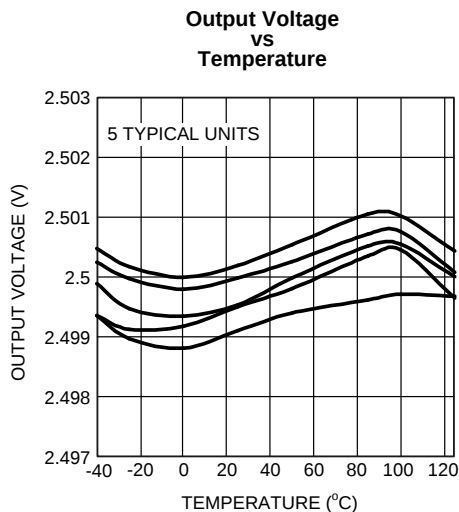


Figure 1.

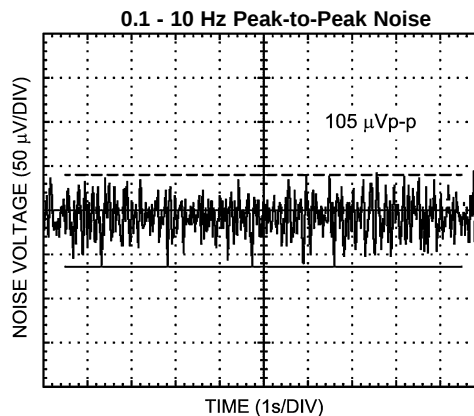


Figure 2.

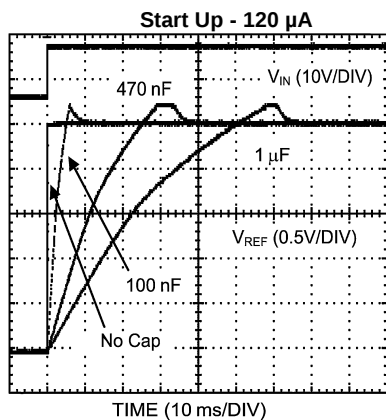


Figure 3.

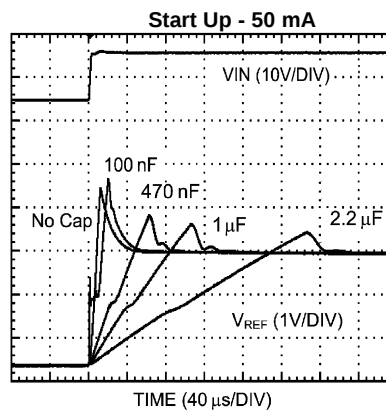


Figure 4.

### Reverse Breakdown Voltage Change with Current

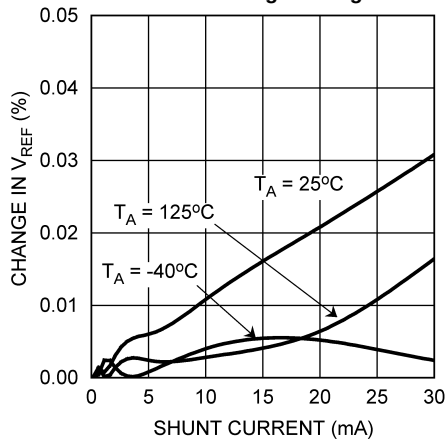


Figure 5.

### Reverse Dynamic Impedance vs Frequency

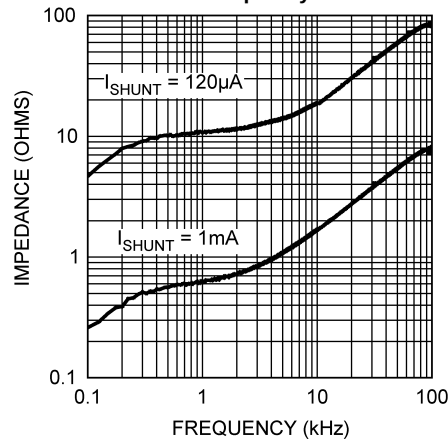


Figure 6.

## Typical Performance Characteristics for 4.096V

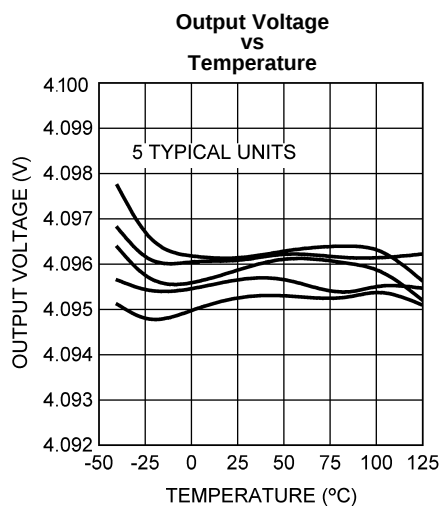


Figure 7.

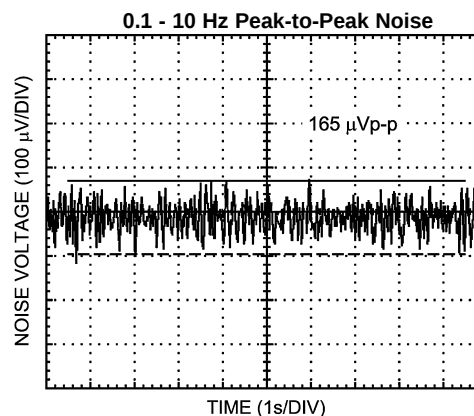


Figure 8.

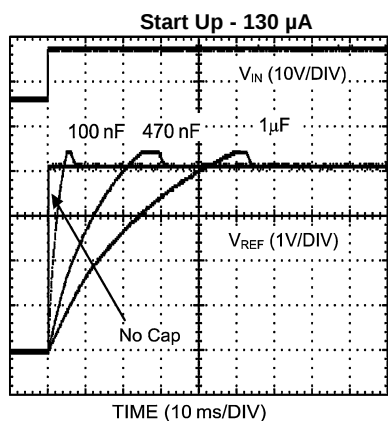


Figure 9.

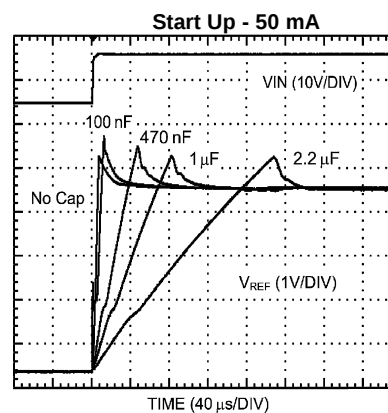


Figure 10.

### Reverse Breakdown Voltage Change with Current

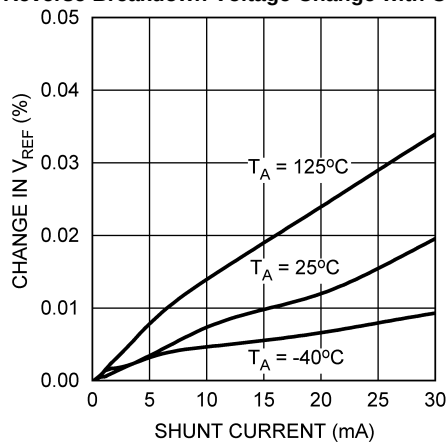


Figure 11.

### Reverse Dynamic Impedance vs Frequency

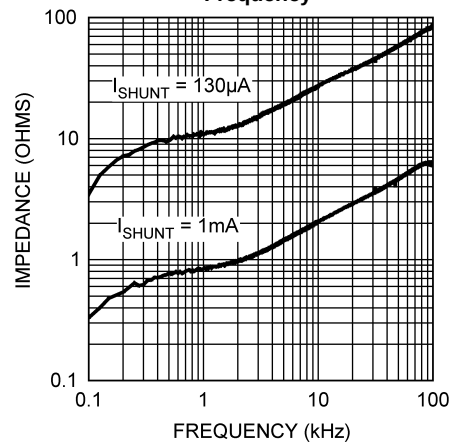


Figure 12.

## Typical Performance Characteristics

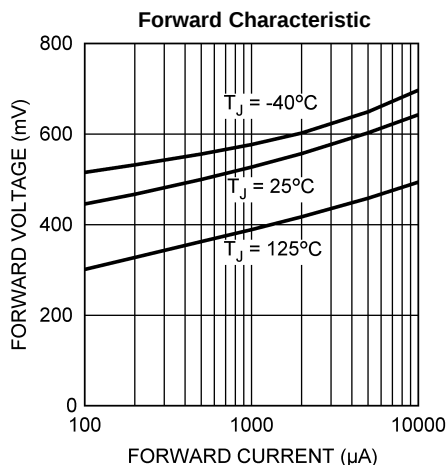


Figure 13.

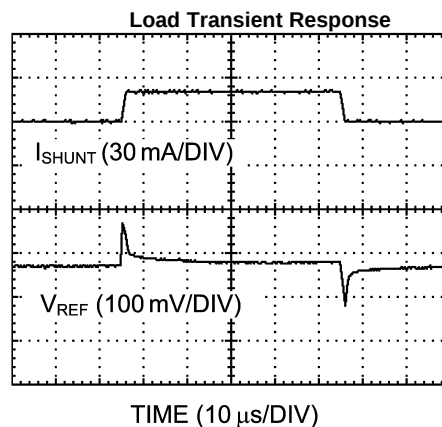


Figure 14.

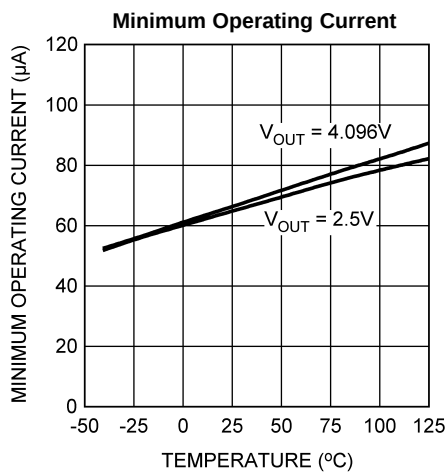


Figure 15.

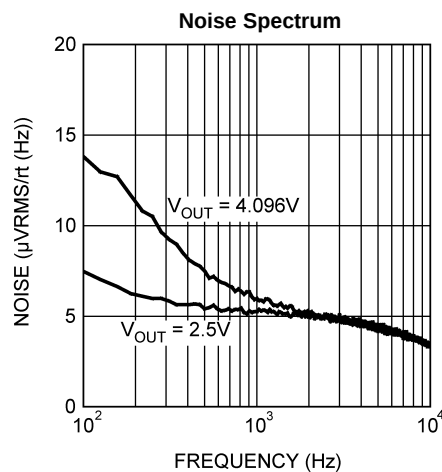


Figure 16.

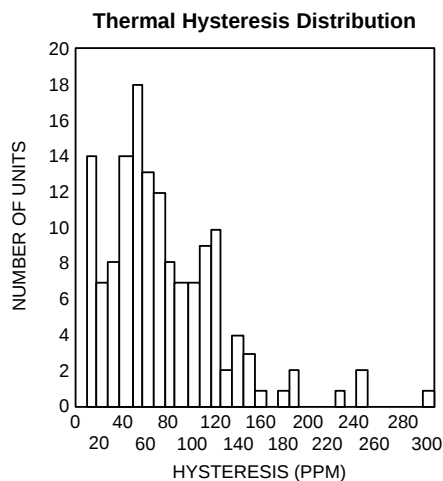


Figure 17.

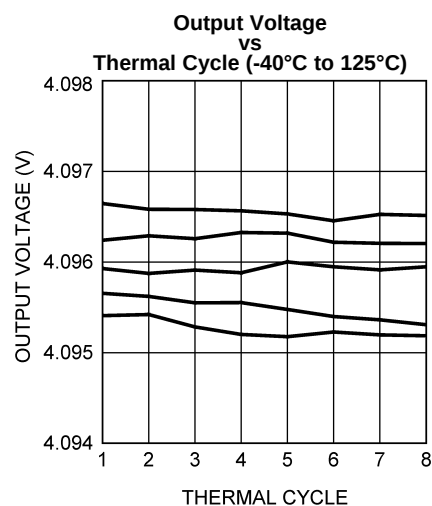
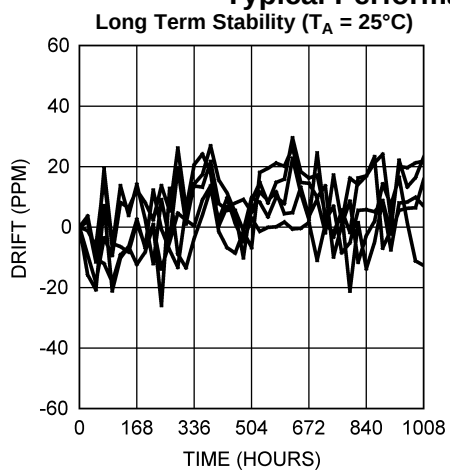
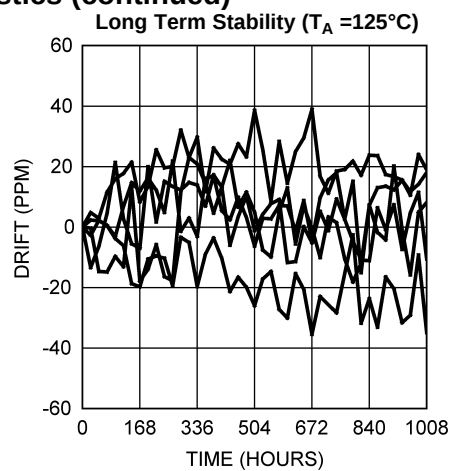


Figure 18.

**Typical Performance Characteristics (continued)****Figure 19.****Figure 20.**

## APPLICATION INFORMATION

### THEORY OF OPERATION

The LM4030 is an ultra-high precision shunt voltage reference, having exceptionally high initial accuracy (0.05%) and temperature stability (10ppm/°C). The LM4030 is available with fixed voltage options of 2.5V and 4.096V. Despite the tiny SOT-23 package, the LM4030 exhibits excellent thermal hysteresis (75ppm) and long-term stability (25ppm). The LM4030 is designed to operate without an external capacitor, but any capacitor up to 10  $\mu$ F may be used. The LM4030 can be powered off as little as 120  $\mu$ A (max) but is capable of shunting up to 30 mA continuously. The typical application circuit for the the LM4030 is shown in Figure 21.

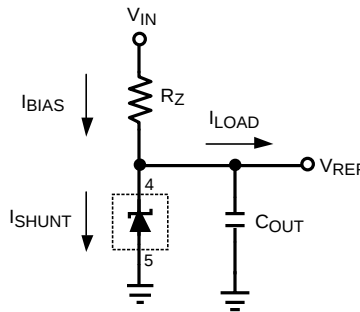


Figure 21. Typical Application Circuit

### COMPONENT SELECTION

A resistor must be chosen to set the maximum operating current for the LM4030 ( $R_Z$  in Figure 21). The value of the resistor can be calculated using the following equation:

$$R_Z = (V_{IN} - V_{REF}) / (I_{MIN\_OPERATING} + I_{LOAD\_MAX}) \quad (1)$$

$R_Z$  is chosen such that the total current flowing through  $R_Z$  is greater than the maximum load current plus the minimum operating current of the reference itself. This ensures that the reference is never starved for current. Running the LM4030 at higher currents is advantageous for reducing noise. The reverse dynamic impedance of the  $V_{REF}$  node scales inversely with the shunted current (see Figure 22) leading to higher rejection of noise emanating from the input supply and from EMI (electro-magnetic interference).

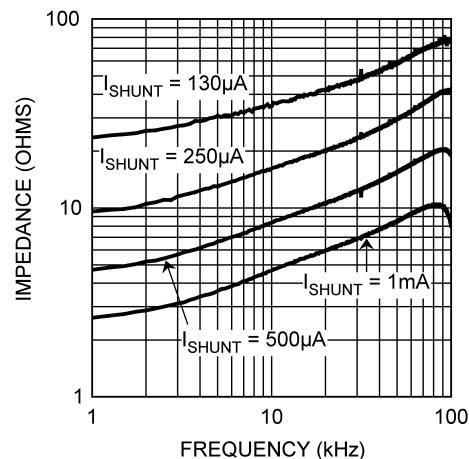
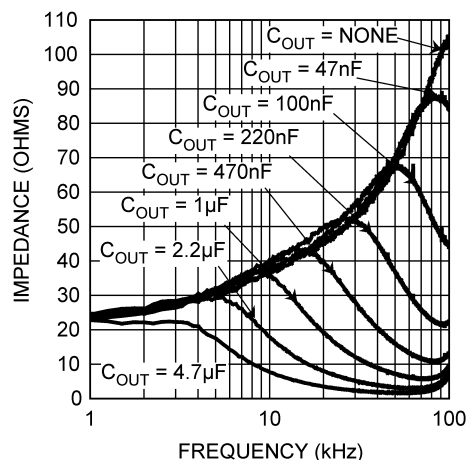


Figure 22. Reverse Dynamic Impedance vs  $I_{OUT}$

The LM4030 is designed to operate with or without a bypass capacitor ( $C_{OUT}$  in Figure 21) and is stable with capacitors of up to 10  $\mu$ F. The use of a bypass capacitor can improve transient response and reduce broadband noise. Additionally, a bypass capacitor will counter the rising reverse dynamic impedance at higher frequencies improving noise immunity (see Figure 23).

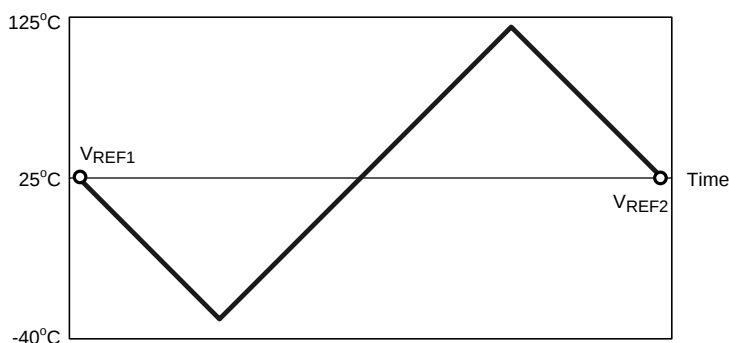


**Figure 23. Reverse Dynamic Impedance vs  $C_{OUT}$**

As with other regulators, an external capacitor reduces the amplitude of the  $V_{REF}$  transient when a sudden change in loading takes place. The capacitor should be placed as close to the part as possible to reduce the effects of unwanted board parasitics.

## THERMAL HYSTERESIS

Thermal hysteresis is defined as the change in output voltage at 25°C after some deviation from 25°C. This is to say that thermal hysteresis is the difference in output voltage between two points in a given temperature profile. An illustrative temperature profile is shown in [Figure 24](#).



**Figure 24. Illustrative Temperature Profile**

This may be expressed analytically as the following:

$$V_{HYS} = \frac{|V_{REF1} - V_{REF2}|}{V_{REF}} \times 10^6 \text{ ppm}$$

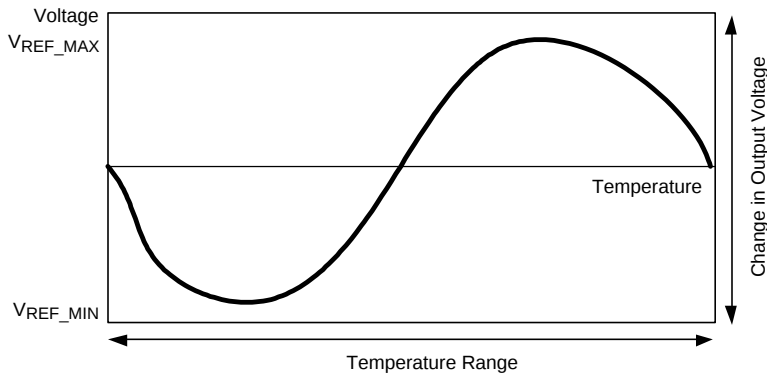
where

- $V_{HYS}$  = Thermal hysteresis expressed in ppm
  - $V_{REF}$  = Nominal preset output voltage
  - $V_{REF1} = V_{REF}$  before temperature fluctuation
  - $V_{REF2} = V_{REF}$  after temperature fluctuation
- (2)

The LM4030 features a low thermal hysteresis of 75 ppm (typical) from -40°C to 125°C after 8 temperature cycles.

## TEMPERATURE COEFFICIENT

Temperature drift is defined as the maximum deviation in output voltage over the temperature range. This deviation over temperature may be illustrated as shown in Figure 25.



**Figure 25. Illustrative  $V_{REF}$  vs Temperature Profile**

Temperature coefficient may be expressed analytically as the following:

$$T_D = \frac{(V_{REF\_MAX} - V_{REF\_MIN})}{V_{REF} \times \Delta T} \times 10^6 \text{ ppm}$$

where

- $T_D$  = Temperature drift
- $V_{REF}$  = Nominal preset output voltage
- $V_{REF\_MIN}$  = Minimum output voltage over operating temperature range
- $V_{REF\_MAX}$  = Maximum output voltage over operating temperature range
- $\Delta T$  = Operating temperature range

(3)

The LM4030 features a low temperature drift of 10ppm (max) to 30ppm (max), depending on the grade.

## DYNAMIC OFFSET CANCELLATION AND LONG TERM STABILITY

Aside from initial accuracy and drift performance, other specifications such as thermal hysteresis and long-term stability can affect the accuracy of a voltage reference, especially over the lifetime of the application. The reference voltage can also shift due to board stress once the part is mounted onto the PCB and during subsequent thermal cycles. Generally, these shifts in  $V_{REF}$  arise due to offsets between matched devices within the regulation loop. Both passive and active devices naturally experience drift over time and stress and temperature gradients across the silicon die also generate offset. The LM4030 incorporates a dynamic offset cancellation scheme which compensates for offsets developing within the regulation loop. This gives the LM4030 excellent long-term stability (40 ppm typical) and thermal hysteresis performance (75ppm typical), as well as substantial immunity to PCB stress effects, despite being packaged in a tiny SOT-23.

## EXPRESSION OF ELECTRICAL CHARACTERISTICS

Electrical characteristics are typically expressed in mV, ppm, or a percentage of the nominal value. Depending on the application, one expression may be more useful than the other. To convert one quantity to the other one may apply the following:

ppm to mV error in output voltage:

$$\frac{V_{REF} \times \text{ppm}_{\text{ERROR}}}{10^3} = V_{\text{ERROR}}$$

where

- $V_{REF}$  is in volts (V) and  $V_{\text{ERROR}}$  is in milli-volts (mV)

(4)

Bit error (1 bit) to voltage error (mV):

$$\frac{V_{REF}}{2^n} \times 10^3 = V_{ERROR} \quad (5)$$

$V_{REF}$  is in volts (V),  $V_{ERROR}$  is in milli-volts (mV), and  $n$  is the number of bits.

mV to ppm error in output voltage:

$$\frac{V_{ERROR}}{V_{REF}} \times 10^3 = \text{ppm}_{ERROR}$$

where

- $V_{REF}$  is in volts (V) and  $V_{ERROR}$  is in milli-volts (mV) (6)

Voltage error (mV) to percentage error (percent):

$$\frac{V_{ERROR}}{V_{REF}} \times 0.1 = \text{Percent\_Error}$$

where

- $V_{REF}$  is in volts (V) and  $V_{ERROR}$  is in milli-volts (mV) (7)

## PRINTED CIRCUIT BOARD and LAYOUT CONSIDERATIONS

The LM4030 has a very small change in reverse voltage with current (25ppm/mA typical) so large variations in load current (up to 50mA) should not appreciably shift  $V_{REF}$ . Parasitic resistance between the LM4030 and the load introduces a voltage drop proportional to load current and should be minimized. The LM4030 should be placed as close to the load it is driving as the layout will allow. The location of  $R_Z$  is not important, but  $C_{OUT}$  should be as close to the LM4030 as possible so added ESR does not degrade the transient performance.

## REVISION HISTORY

### Changes from Revision A (April 2013) to Revision B

### Page

- Changed layout of National Data Sheet to TI format ..... [12](#)

## PACKAGING INFORMATION

| Orderable Device     | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|----------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| LM4030AMF-2.5/NOPB   | ACTIVE        | SOT-23       | DBV             | 5    | 1000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | R5JA                    | <a href="#">Samples</a> |
| LM4030AMF-4.096/NOPB | ACTIVE        | SOT-23       | DBV             | 5    | 1000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | R5KA                    | <a href="#">Samples</a> |
| LM4030AMFX-2.5/NOPB  | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | R5JA                    | <a href="#">Samples</a> |
| LM4030BMF-2.5/NOPB   | ACTIVE        | SOT-23       | DBV             | 5    | 1000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | R5JB                    | <a href="#">Samples</a> |
| LM4030BMF-4.096/NOPB | ACTIVE        | SOT-23       | DBV             | 5    | 1000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | R5KB                    | <a href="#">Samples</a> |
| LM4030BMFX-2.5/NOPB  | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | R5JB                    | <a href="#">Samples</a> |
| LM4030BMFX4.096/NOPB | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | R5KB                    | <a href="#">Samples</a> |
| LM4030CMF-2.5/NOPB   | ACTIVE        | SOT-23       | DBV             | 5    | 1000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | R5JC                    | <a href="#">Samples</a> |
| LM4030CMF-4.096/NOPB | ACTIVE        | SOT-23       | DBV             | 5    | 1000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | R5KC                    | <a href="#">Samples</a> |
| LM4030CMFX-2.5/NOPB  | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | R5JC                    | <a href="#">Samples</a> |
| LM4030CMFX4.096/NOPB | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | SN                                   | Level-1-260C-UNLIM   | -40 to 125   | R5KC                    | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

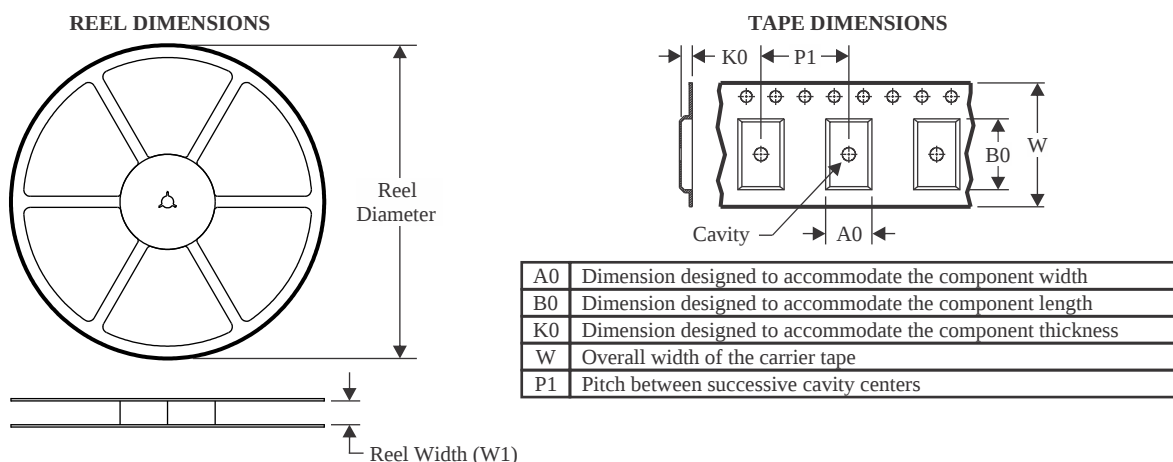
<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

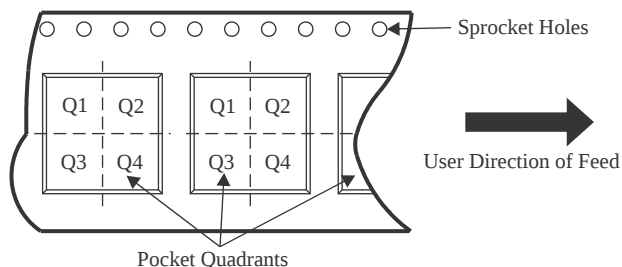
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## TAPE AND REEL INFORMATION



### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



\*All dimensions are nominal

| Device               | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| LM4030AMF-2.5/NOPB   | SOT-23       | DBV             | 5    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM4030AMF-4.096/NOPB | SOT-23       | DBV             | 5    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM4030AMFX-2.5/NOPB  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM4030BMF-2.5/NOPB   | SOT-23       | DBV             | 5    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM4030BMF-4.096/NOPB | SOT-23       | DBV             | 5    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM4030BMFX-2.5/NOPB  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM4030BMFX4.096/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM4030CMF-2.5/NOPB   | SOT-23       | DBV             | 5    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM4030CMF-4.096/NOPB | SOT-23       | DBV             | 5    | 1000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM4030CMFX-2.5/NOPB  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| LM4030CMFX4.096/NOPB | SOT-23       | DBV             | 5    | 3000 | 178.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device               | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LM4030AMF-2.5/NOPB   | SOT-23       | DBV             | 5    | 1000 | 208.0       | 191.0      | 35.0        |
| LM4030AMF-4.096/NOPB | SOT-23       | DBV             | 5    | 1000 | 208.0       | 191.0      | 35.0        |
| LM4030AMFX-2.5/NOPB  | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LM4030BMF-2.5/NOPB   | SOT-23       | DBV             | 5    | 1000 | 208.0       | 191.0      | 35.0        |
| LM4030BMF-4.096/NOPB | SOT-23       | DBV             | 5    | 1000 | 208.0       | 191.0      | 35.0        |
| LM4030BMFX-2.5/NOPB  | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LM4030BMFX4.096/NOPB | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LM4030CMF-2.5/NOPB   | SOT-23       | DBV             | 5    | 1000 | 208.0       | 191.0      | 35.0        |
| LM4030CMF-4.096/NOPB | SOT-23       | DBV             | 5    | 1000 | 208.0       | 191.0      | 35.0        |
| LM4030CMFX-2.5/NOPB  | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |
| LM4030CMFX4.096/NOPB | SOT-23       | DBV             | 5    | 3000 | 208.0       | 191.0      | 35.0        |

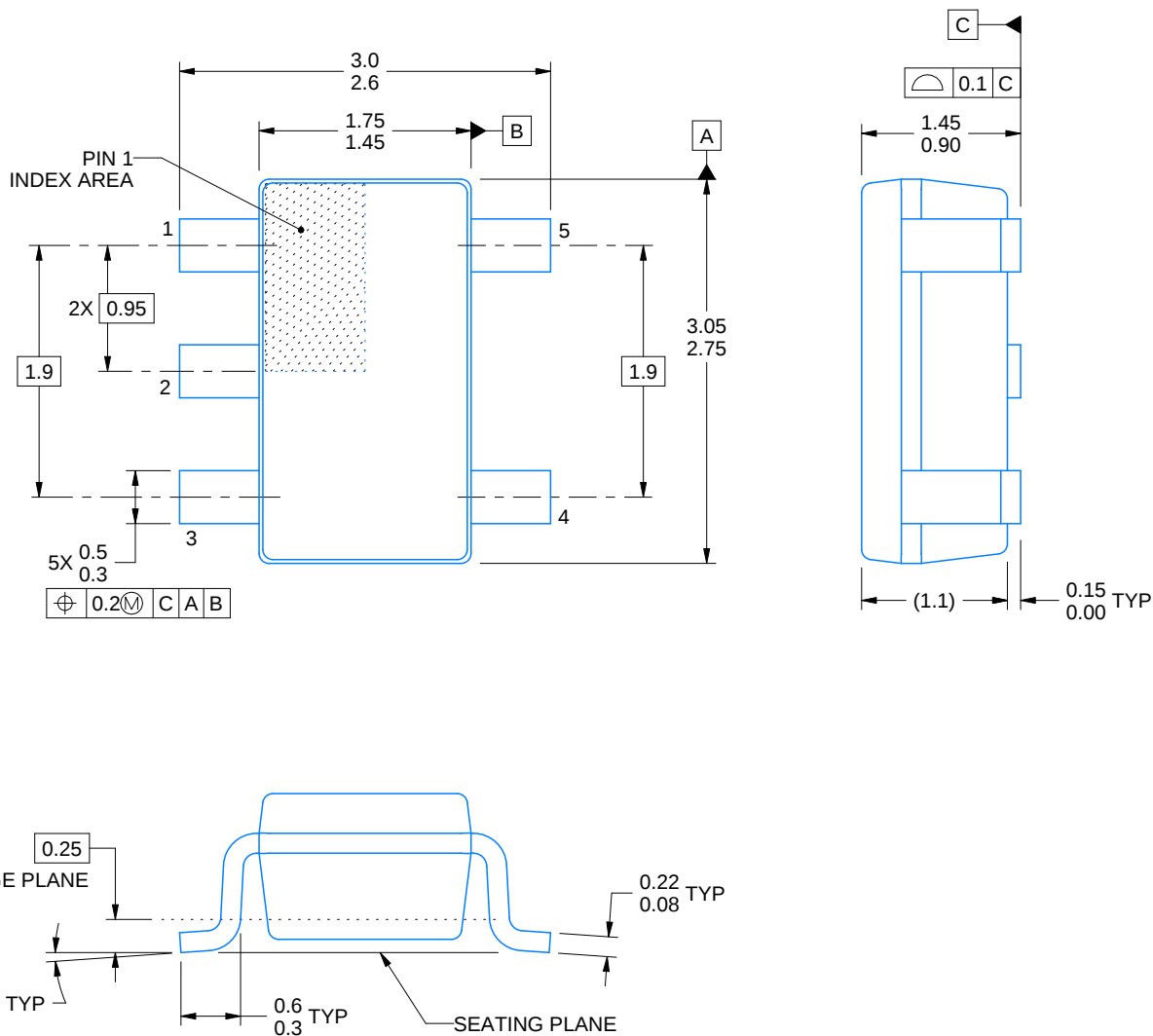


DBV0005A

# PACKAGE OUTLINE

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



4214839/F 06/2021

## NOTES:

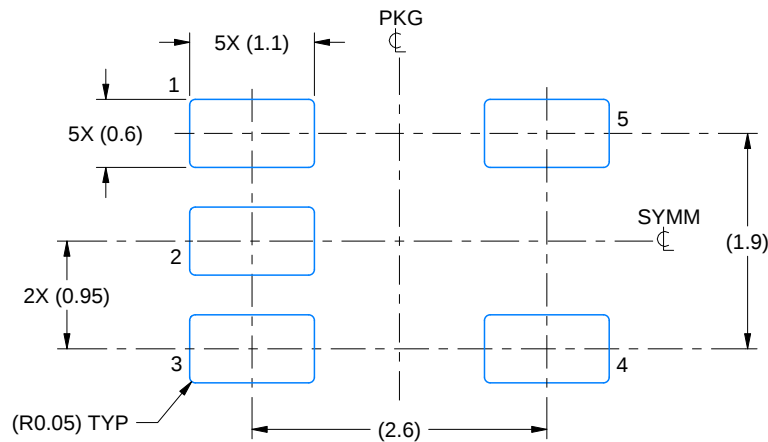
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC MO-178.
4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.

# EXAMPLE BOARD LAYOUT

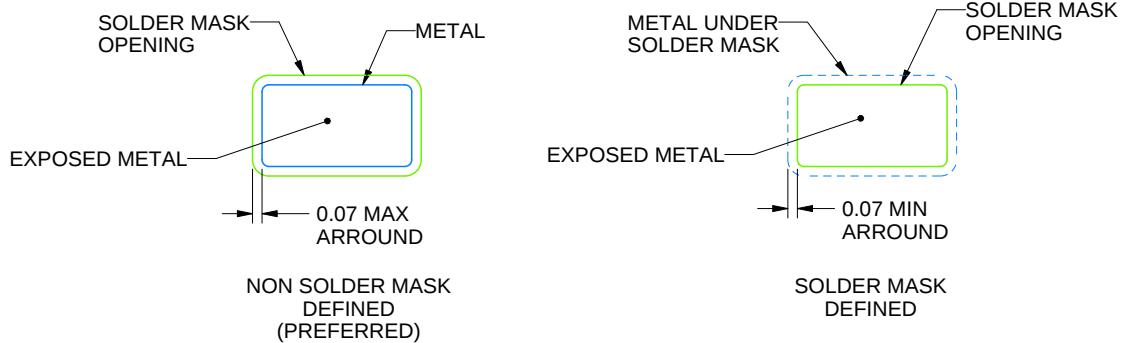
DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



SOLDER MASK DETAILS

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NOTES: (continued)

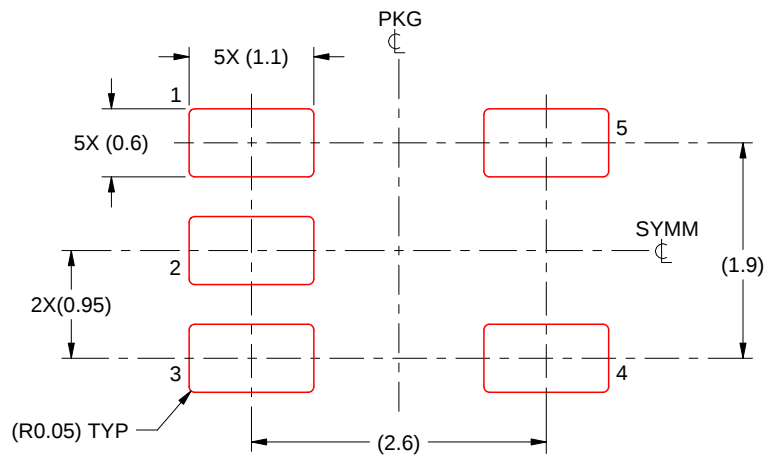
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:15X

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NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

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